



# SPECIFICATION

(Reference sheet)

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor

## A. Samsung Part Number

CL 10 A 106 M Q 8 N N N C  
 ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

① Series	Samsung Multi-layer Ceramic Capacitor		
② Size	0603 (inch code)	L: $1.6 \pm 0.1$ mm	W: $0.8 \pm 0.1$ mm
③ Dielectric	X5R	⑧ Inner electrode	Ni
④ Capacitance	$10 \mu\text{F}$	Termination	Cu
⑤ Capacitance tolerance	$\pm 20\%$	Plating	Sn 100% (Pb Free)
⑥ Rated Voltage	6.3 V	⑨ Product	Normal
⑦ Thickness	$0.8 \pm 0.1$ mm	⑩ Special	Reserved for future use
		⑪ Packaging	Cardboard Type, 7" reel

## B. Samsung Reliability Test and Judgement condition

	Performance	Test condition	
Capacitance	Within specified tolerance	$1\text{kHz} \pm 10\%$	$0.5 \pm 0.1\text{Vrms}$
Tan $\delta$ (DF)	0.1 max.		
Insulation Resistance	10,000Mohm or $100\text{Mohm} \cdot \mu\text{F}$ Whichever is Smaller	Rated Voltage	60~120 sec.
Appearance	No abnormal exterior appearance	Microscope ( $\times 10$ )	
Withstanding Voltage	No dielectric breakdown or mechanical breakdown	250% of the rated voltage	
Temperature Characteristics	X5R (From $-55^\circ\text{C}$ to $85^\circ\text{C}$ , Capacitance change should be within $\pm 15\%$ )		
Adhesive Strength of Termination	No peeling shall be occur on the terminal electrode	500g·F, for $10 \pm 1$ sec.	
Bending Strength	Capacitance change : within $\pm 12.5\%$	Bending to the limit (1mm) with 1.0mm/sec.	
Solderability	More than 75% of terminal surface is to be soldered newly	SnAg3.0Cu0.5 solder $245 \pm 5^\circ\text{C}$ , $3 \pm 0.3$ sec. (preheating : $80 \sim 120^\circ\text{C}$ for 10~30sec.)	
Resistance to Soldering heat	Capacitance change : within $\pm 7.5\%$ Tan $\delta$ , IR : initial spec.	Solder pot : $270 \pm 5^\circ\text{C}$ , $10 \pm 1$ sec.	

	Performance	Test condition
<b>Vibration Test</b>	Capacitance change : within $\pm 5\%$ Tan $\delta$ , IR : initial spec.	Amplitude : 1.5mm From 10Hz to 55Hz (return : 1min.) 2hours $\times$ 3 direction (x, y, z)
<b>Moisture Resistance</b>	Capacitance change : within $\pm 12.5\%$ Tan $\delta$ : 0.125 max IR : $12.5\text{M}\Omega \cdot \mu\text{F}$ or Over	With rated voltage $40 \pm 2^\circ\text{C}$ , 90~95%RH, 500+12/-0hrs
<b>High Temperature Resistance</b>	Capacitance change : within $\pm 12.5\%$ Tan $\delta$ : 0.125 max IR : $25\text{M}\Omega \cdot \mu\text{F}$ or Over	With 150% of the rated voltage Max. operating temperature 1000+48/-0hrs
<b>Temperature Cycling</b>	Capacitance change : within $\pm 7.5\%$ Tan $\delta$ , IR : initial spec.	1 cycle condition Min. operating temperature $\rightarrow 25^\circ\text{C}$ $\rightarrow$ Max. operating temperature $\rightarrow 25^\circ\text{C}$ 5 cycle test

#### C. Recommended Soldering method :

Reflow ( Reflow Peak Temperature :  $260 \pm 0/-5^\circ\text{C}$ , 10sec. Max )

 Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,  
please contact our sales personnel or application engineers.